

5452/7452 Expandable 4-Wide AND-OR Gate

	Schottky TTL				High-Speed TTL				Low-Power Schottky TTL				Standard TTL				Low-Power TTL				
	Device Type	Package			Device Type	Package			Device Type	Package			Device Type	Package			Device Type	Package			
		C	P	M		C	P	M		C	P	M		C	P	M		C	P	M	
T.I.					SN54H52	J(1)		W(2)													
FAIRCHILD					SN74H52	J(1)	N(2)														
MOTOROLA					FMS4H52/FC9H52	D(1)		F(2)													
N.S.C.					FO74H52/FC9H52	D(1)	P(1)														
PHILIPS					MC3131	L(1)		F(1)													
SIGNETICS					MC3031	L(1)	P(1)	F(1)													
SIEMENS					DM54H52	J(1)	N(2)														
FUJITSU					DM74H52	J(1)	N(2)														
HITACHI					N74H52	J(1)															
MITSUBISHI					S54H52	F(1)	A(1)	W(2)													
NEC					N74H52	F(1)	A(1)														
TOSHIBA																					

Electrical Characteristics SN54H52/SN74H52

absolute maximum ratings over operating free-air temperature range

Supply voltage, V _{CC}	7V	Operating free-air temperature range	SN54H52: -55°C to 125°C SN74H52: 0°C to 70°C
Input voltage	5.5V		
Intermittent voltage	5.5V	Storage temperature range	-65°C to 150°C
recommended operating conditions			
	SN54H52	SN74H52	UNIT
Supply voltage, V _{CC}	MIN. 4.5	NOM. 5	MAX. 5.5
High-level output current, I _{OH}	-500		μA
Low-level output current, I _{OL}	20		mA
Operating free-air temperature, T _A	-55	125	0
			°C

electrical characteristics over recommended operating free-air temperature range

PARAMETER	TEST CONDITIONS†	MIN	TYP‡	MAX	UNIT
V _{IH} High-level input voltage			2		V
V _{IL} Low-level input voltage			0.8		V
V _I Input clamp voltage	V _{CC} =MIN, I _I =-8mA		-1.5		V
V _{OH} High-level output voltage	V _{CC} =MIN, V _{OH} =2V	2.4	3.4		V
V _{OL} Low-level output voltage	V _{CC} =MIN, V _{OL} =V _{IL} max	0.2	0.4		V
I _I Input current at maximum input voltage	V _{CC} =MAX, V _I =5.5V		1		mA
I _{IH} High-level input current	Data input V _{CC} =MIX, V _{IH} =2.4V		50		μA
I _{IL} Low-level input current	Data inputs V _{CC} =MAX, V _{IL} =0.4V	-- 2			mA
I _{OS} Short-circuit output current	V _{CC} =MAX	-40	-100		mA
I _{ICCH} Supply current	V _{CC} =MAX	Total, outputs high 20	31		mA
I _{ICL} Supply current	V _{CC} =MAX	Total, outputs low 15.2	24		mA
I _{IC} Supply current	V _{CC} =5V	Average per gate 17.6			mA
I _{PLH} Propagation delay time, low-to-high-level output	V _{CC} =5V, Expander pins open	10.6	15		ns
	T _A =25°C, C=15pF (GND to x)	14.8			
I _{PHL} Propagation delay time, high-to-low-level output	C _L =25pF, R _L =280Ω, C=15pF(GND to x)	9.2	15		ns
I _X expander current	V _{CC} =MIN, V _x =1V, T _A =MIN, I _{OH} =-500μA	-2.7	4.5		mA
V _{OH} High-level output voltage	V _{CC} =MIN, V _x =1V, T _A =MIN, I _{OH} =-500μA	2.4	3.4		V
V _{OL} Low-level output voltage	V _{CC} =MIN, T _A =MAX, I _x =-300μA, I _{OL} =20mA	0.2	0.4		V

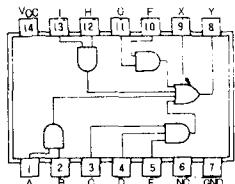
Pin Assignments (Top View)

'H52(J, N) ①

positive logic:

Y = AB + CDE + FG + HI + X

X = output of SN54H61/SN74H61

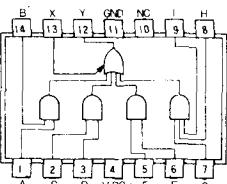


'H52(W) ②

positive logic:

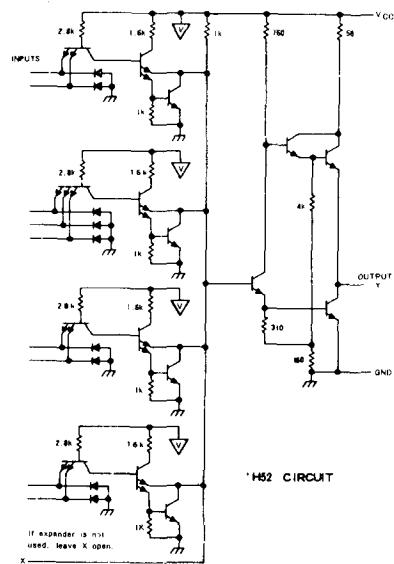
Y = AB + CD + EF + GH + X

X = output of SN54H61/SN74H61



NC = No internal connection

Schematic (each gate)



Resistor values shown are nominal and in ohms.

†For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

‡All typical values are at V_{CC}=5V, T_A=25°C.

◆Not more than one output should be shorted at a time, and for the SN54H52/SN74H52, duration of short-circuit should not exceed one second.